

# Advanced Semiconductor Packaging Market anticipated to surpass US\$52.782 billion by 2030 at a CAGR of 7.28%

The advanced semiconductor packaging market is anticipated to grow at a CAGR of 7.28% from US\$37.137 billion in 2025 to US\$52.782 billion by 2030.

NEW YORK, NY, UNITED STATES, June 4, 2025 /EINPresswire.com/ -- According to a new study published by Knowledge Sourcing Intelligence, the advanced semiconductor packaging market is projected to grow at a CAGR of 7.28% between 2025 and 2030 to reach US\$52.782 billion by 2030.



The global advanced <u>semiconductor</u>

<u>packaging market</u> is expected to experience significant growth in the coming years, according to a new report by industry experts. The market, which includes advanced <u>packaging</u> technologies such as 3D packaging, fan-out wafer-level packaging, and system-in-package.



The advanced semiconductor packaging market is anticipated to grow at a CAGR of 7.28% from US\$37.137 billion in 2025 to US\$52.782 billion by 2030."

Knowledge Sourcing Intelligence The increasing demand for smaller, faster, and more efficient electronic devices is one of the key factors driving the growth of the advanced semiconductor packaging market. With the rise of technologies such as 5G, artificial intelligence, and Internet of Things, there is a growing need for advanced packaging solutions that can meet the performance and power requirements of these applications.

The report also highlights the role of technological advancements in the growth of the market. The development of new packaging techniques, such as wafer-

level packaging and flip-chip packaging, has enabled manufacturers to produce smaller and

more powerful devices. Additionally, the use of advanced materials, such as copper and low-k dielectrics, has improved the performance and reliability of semiconductor packages.

The Asia-Pacific region is expected to dominate the advanced semiconductor packaging market, with countries like China, Japan, and South Korea leading the way. The region is home to some of the largest semiconductor manufacturers and has a strong presence in the consumer electronics market. The increasing demand for smartphones, tablets, and other electronic devices in this region is expected to drive the growth of the advanced semiconductor packaging market.

Overall, the advanced semiconductor packaging market is poised for significant growth in the coming years, driven by technological advancements and the increasing demand for smaller and more powerful electronic devices. As the market continues to evolve, it presents opportunities for both established players and new entrants to innovate and capitalize on the growing demand for advanced packaging solutions.

Access sample report or view details: <a href="https://www.knowledge-sourcing.com/report/advanced-semiconductor-packaging-market">https://www.knowledge-sourcing.com/report/advanced-semiconductor-packaging-market</a>

As a part of the report, the major players operating in the advanced semiconductor packaging market that have been covered are Intel Corporation, Taiwan Semiconductor Manufacturing Company Limited, Samsung, Amkor Technology Inc, among others.

The market analytics report segments the advanced semiconductor packaging market as follows:

# By Packaging Type

- Flip Chip
- Fan-Out Wafer-Level Packaging (FOWLP)
- Embedded Die
- Others

# By Application

- Consumer Electronics
- Automotive
- Telecommunications
- Others

## By End-User

- Foundries
- Integrated Device Manufacturers (IDMs)

### By Region

- Americas
- o US
- · Europe Middle East and Africa
- o Germany
- o Netherland
- o Others
- Asia Pacific
- o China
- o Japan
- o Taiwan
- o South Korea
- o Others

### Companies Profiled:

- Intel Corporation
- Taiwan Semiconductor Manufacturing Company Limited
- Samsung
- Amkor Technology Inc
- Fujitsu Limited

### Reasons for Buying this Report:-

- Insightful Analysis: Gain detailed market insights covering major as well as emerging geographical regions, focusing on customer segments, government policies and socio-economic factors, consumer preferences, industry verticals, other sub-segments.
- Competitive Landscape: Understand the strategic maneuvers employed by key players globally to understand possible market penetration with the correct strategy.
- Market Drivers & Future Trends: Explore the dynamic factors and pivotal market trends and how they will shape future market developments.
- Actionable Recommendations: Utilize the insights to exercise strategic decision to uncover new business streams and revenues in a dynamic environment.
- Caters to a Wide Audience: Beneficial and cost-effective for startups, research institutions, consultants, SMEs, and large enterprises.

What do Businesses use our Reports for?

Industry and Market Insights, Opportunity Assessment, Product Demand Forecasting, Market Entry Strategy, Geographical Expansion, Capital Investment Decisions, Regulatory Framework & Implications, New Product Development, Competitive Intelligence

## Report Coverage:

- Historical data from 2022 to 2024 & forecast data from 2025 to 2030
- Growth Opportunities, Challenges, Supply Chain Outlook, Regulatory Framework, Customer Behaviour, and Trend Analysis
- Competitive Positioning, Strategies, and Market Share Analysis
- Revenue Growth and Forecast Assessment of segments and regions including countries
- Company Profiling (Strategies, Products, Financial Information, and Key Developments among others)

### **Explore More Reports:**

- Global Pharmaceutical Packaging Market: <a href="https://www.knowledge-sourcing.com/report/global-pharmaceutical-packaging-market">https://www.knowledge-sourcing.com/report/global-pharmaceutical-packaging-market</a>
- Sustainable Packaging Market: <a href="https://www.knowledge-sourcing.com/report/sustainable-packaging-market">https://www.knowledge-sourcing.com/report/sustainable-packaging-market</a>
- Luxury Packaging Market: <a href="https://www.knowledge-sourcing.com/report/luxury-packaging-market">https://www.knowledge-sourcing.com/report/luxury-packaging-market</a>
- Protective Packaging Market: <a href="https://www.knowledge-sourcing.com/report/protective-packaging-market">https://www.knowledge-sourcing.com/report/protective-packaging-market</a>
- Global Blister Packaging Market: <a href="https://www.knowledge-sourcing.com/report/global-blister-packaging-market">https://www.knowledge-sourcing.com/report/global-blister-packaging-market</a>

### About Us

Knowledge Sourcing Intelligence (KSI) is a market research and intelligence provider that uses a combination of quantitative and qualitative research techniques to deliver comprehensive, indepth insights to clients. Our approach to market research is centered around the concept of 'Knowledge Sourcing' - the process of gathering data and insights from multiple sources to create a comprehensive and well-rounded picture of the market. KSI's core services include market intelligence, competitive intelligence, customer intelligence, and product intelligence. KSI's approach to market research is designed to help clients make informed decisions, identify opportunities, and gain a better understanding of their target markets. By using a combination of primary and secondary research techniques, we provide clients with detailed insights into current market trends, customer profiles, competitor analysis, and product performance. KSI's market research and intelligence services enable clients to make informed decisions, develop

strategic plans, and identify areas of opportunity.

Harsh Sharma
Knowledge Sourcing Intelligence LLP
+1 850-250-1698
info@knowledge-sourcing.com
Visit us on social media:
LinkedIn
Facebook
X

This press release can be viewed online at: https://www.einpresswire.com/article/818965159

EIN Presswire's priority is source transparency. We do not allow opaque clients, and our editors try to be careful about weeding out false and misleading content. As a user, if you see something we have missed, please do bring it to our attention. Your help is welcome. EIN Presswire, Everyone's Internet News Presswire™, tries to define some of the boundaries that are reasonable in today's world. Please see our Editorial Guidelines for more information. © 1995-2025 Newsmatics Inc. All Right Reserved.